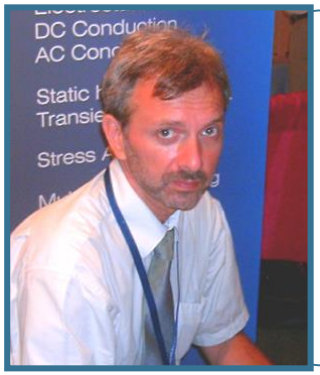
What's new in QuickField 6.2



Vladimir Podnos,
Director of Marketing and Support,
Tera Analysis Ltd.
New features overview

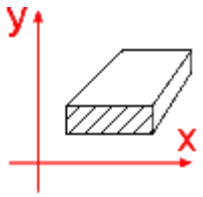
Alexander Lyubimtsev
Support Engineer,
Tera Analysis Ltd.
QuickField live demonstration

What's new in QuickField 6.2

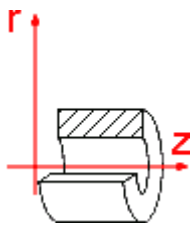
- 3D DC Conduction
- 3D Heat transfer
- Magnetic core losses calculation

QuickField: before 6.0

Magnetic analysis suite	
Magnetic Problems	2D Magnetostatics
	2D AC Magnetics
	2D Transient Magnetics
Electric analysis suite	
Electric Problems	2D Electrostatics and 2D DC Conduction
	2D AC Conduction
	Transient 2D Electric field
Thermostructural analysis suite	
Thermal and mechanical problems	Steady-State 2D Heat transfer
	Transient 2D Heat transfer
	2D Stress analysis



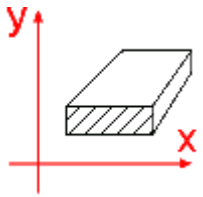
plane-parallel



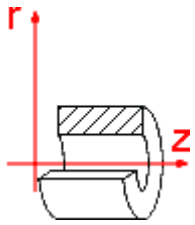
axisymmetric

QuickField 6.0

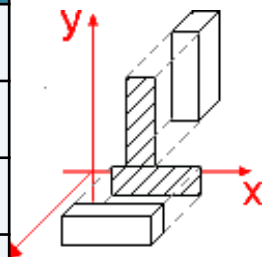
Magnetic analysis suite	
Magnetic Problems	2D Magnetostatics
	2D AC Magnetics
	2D Transient Magnetics
Electric analysis suite	
Electric Problems	2D Electrostatics and 2D DC Conduction
	3D Extrusion Electrostatics free preview
	2D AC Conduction
	Transient 2D Electric field
Thermostructural analysis suite	
Thermal and mechanical problems	Steady-State 2D Heat transfer
	Transient 2D Heat transfer
	2D Stress analysis



plane-parallel



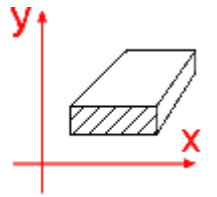
axisymmetric



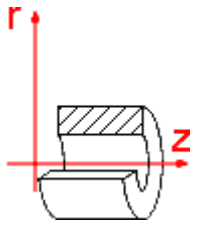
3D extrusion

QuickField 6.1

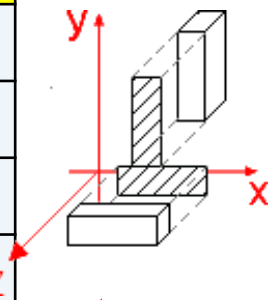
Magnetic analysis suite	
Magnetic Problems	2D Magnetostatics
	2D AC Magnetics
	2D Transient Magnetics
Electric analysis suite	
Electric Problems	2D Electrostatics and 2D DC Conduction
	3D Extrusion + 3D CAD Import Electrostatics
	2D AC Conduction
	Transient 2D Electric field
Thermostructural analysis suite	
Thermal and mechanical problems	Steady-State 2D Heat transfer
	Transient 2D Heat transfer
	2D Stress analysis



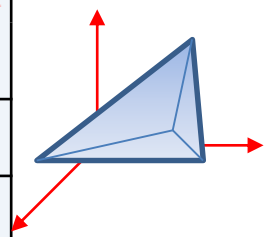
plane-parallel



axisymmetric



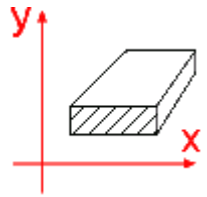
3D extrusion



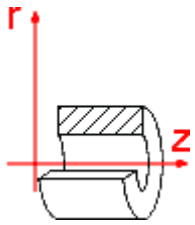
3D import

QuickField 6.2

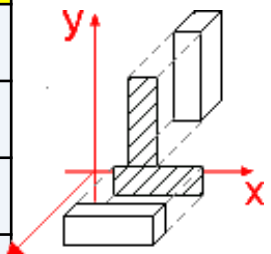
Magnetic analysis suite	
Magnetic Problems	2D Magnetostatics
	2D AC Magnetics
	2D Transient Magnetics
Electric analysis suite	
Electric Problems	2D Electrostatics and 2D DC Conduction
	3D Electrostatics + 3D DC Conduction
	2D AC Conduction
	Transient 2D Electric field
Thermostructural analysis suite	
Thermal and mechanical problems	Steady-State 2D Heat transfer
	Steady-State 3D Heat transfer
	Transient 2D Heat transfer
	2D Stress analysis



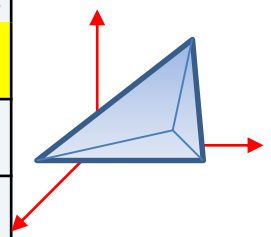
plane-parallel



axisymmetric

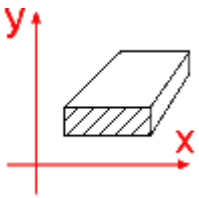


3D extrusion



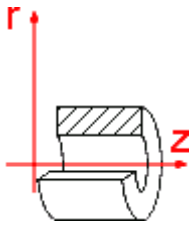
3D import

2D means:



plane-parallel

or



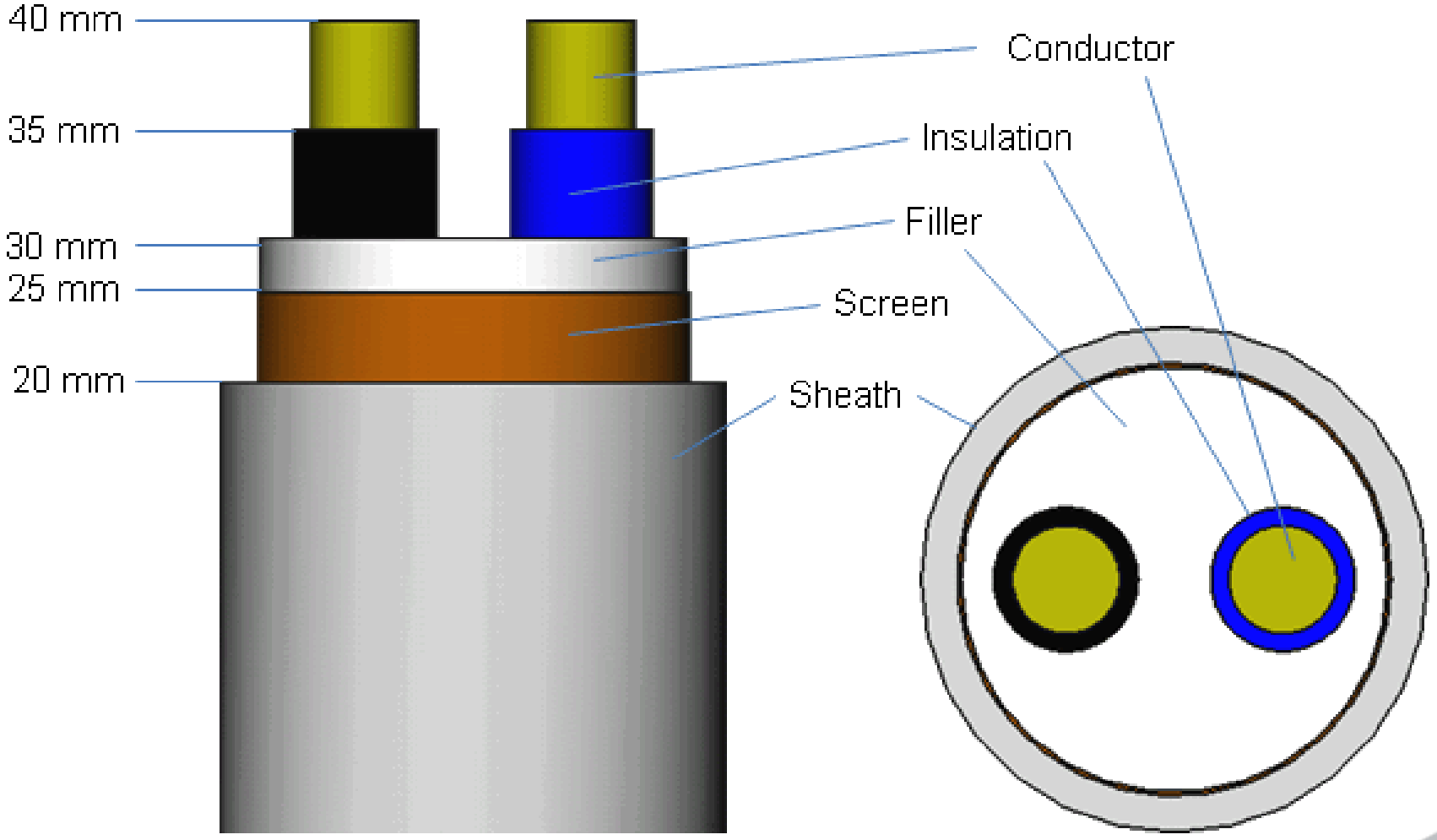
axisymmetric

3D geometry types

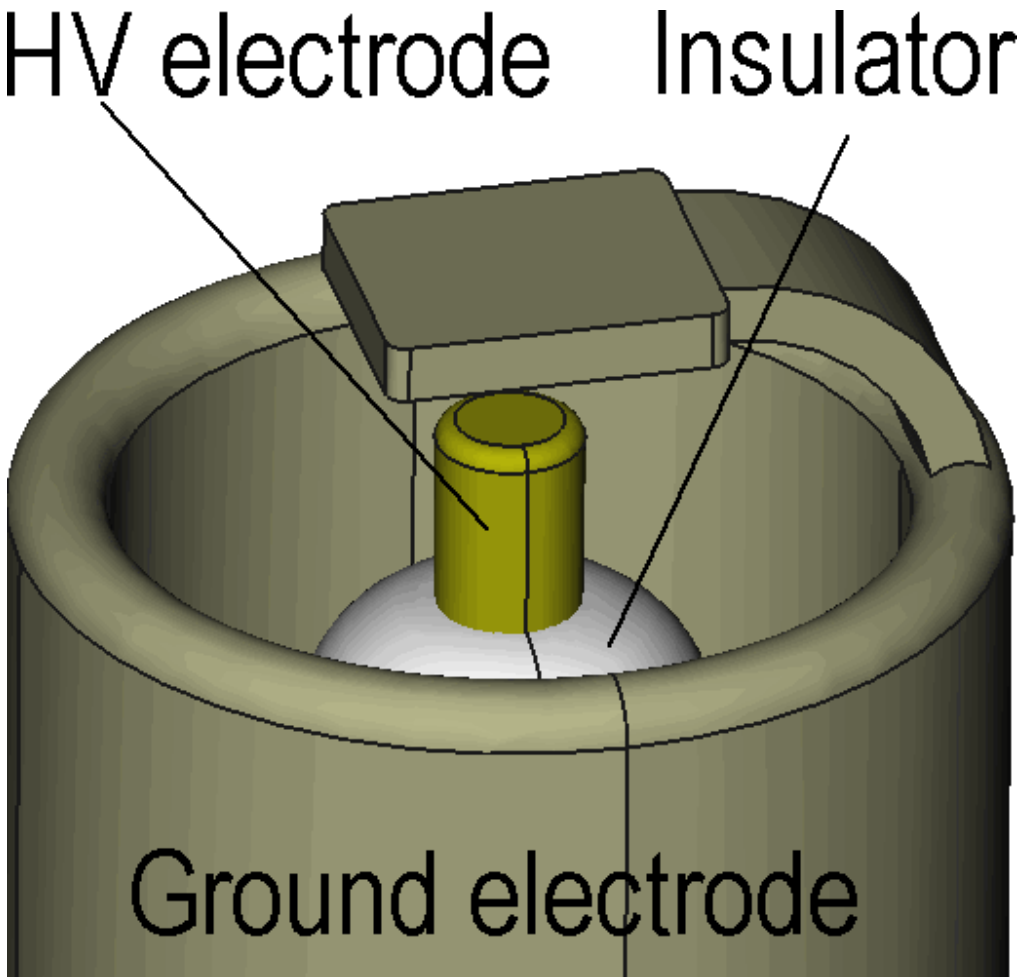
Can be extruded

Can not be extruded

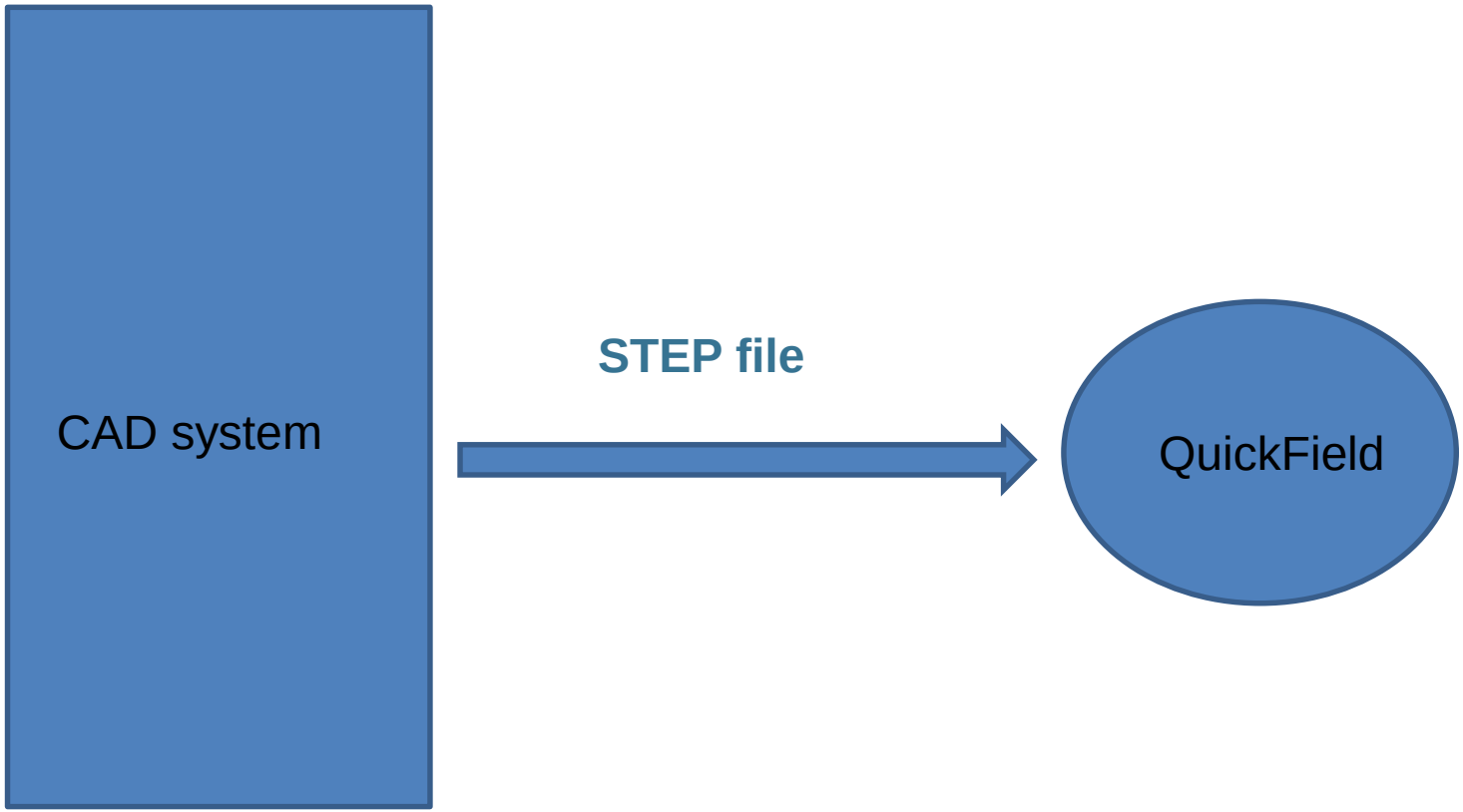
3D Extrusion



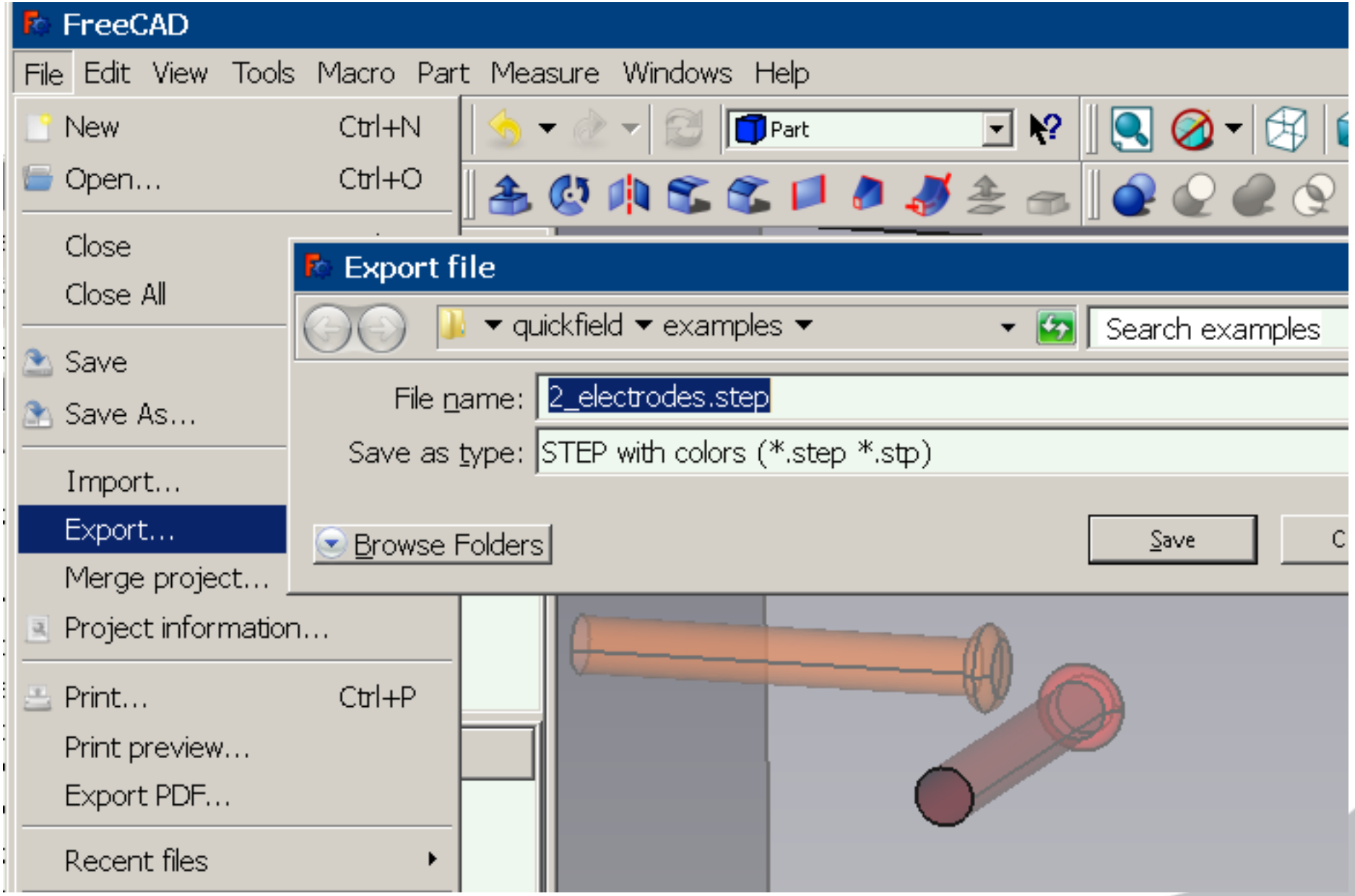
3D CAD Import



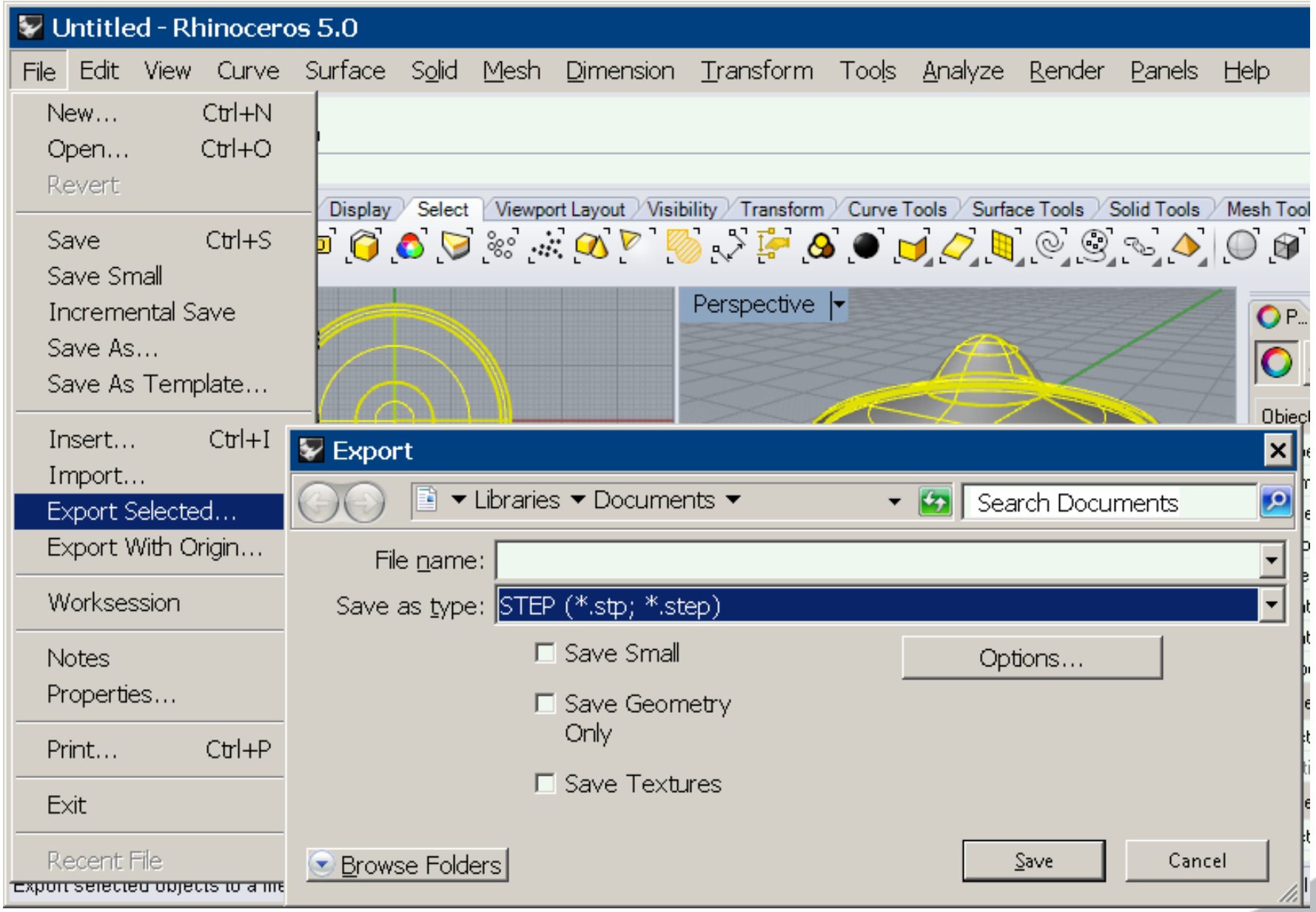
3D CAD model import



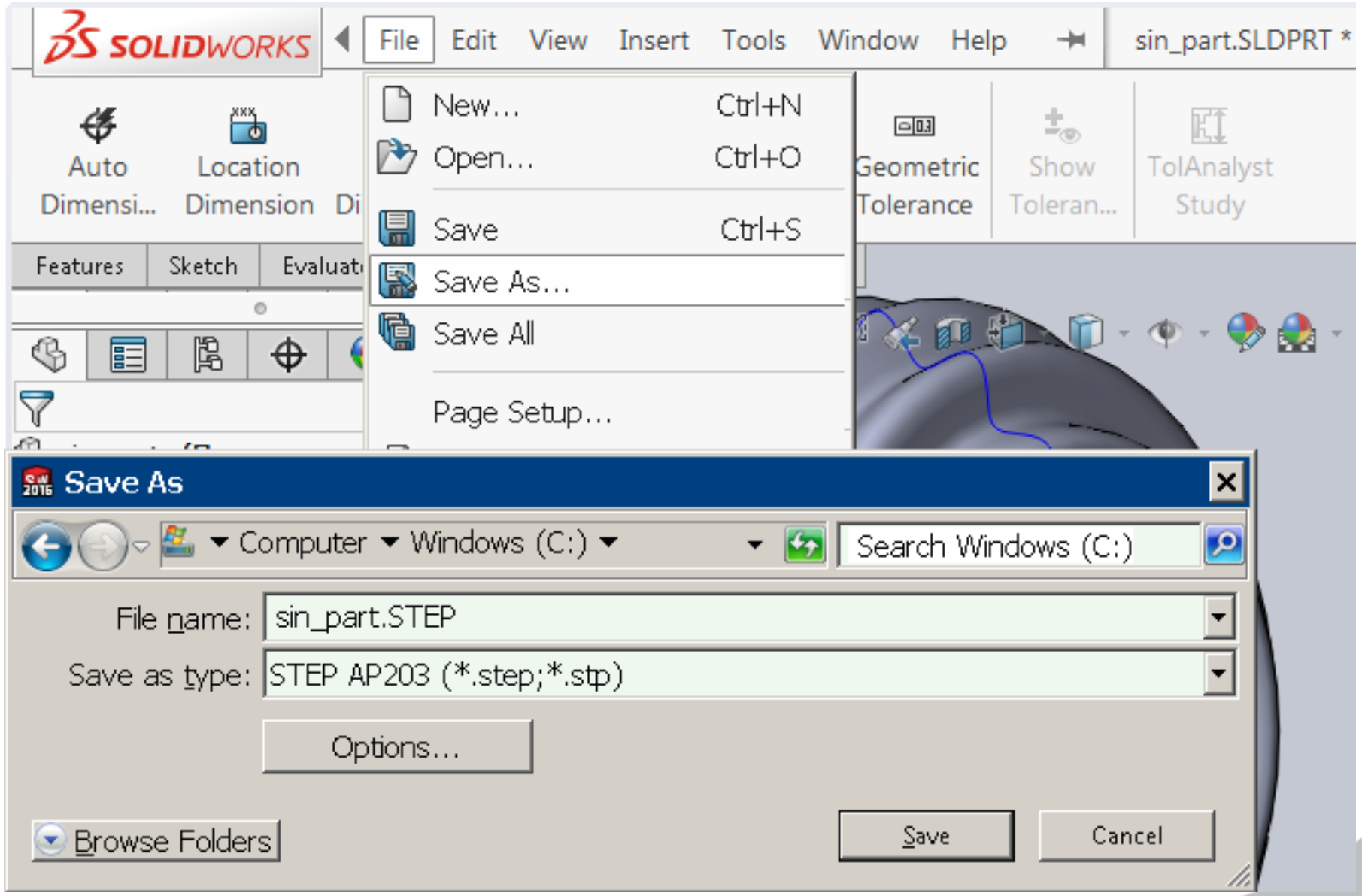
STEP file export from FreeCAD



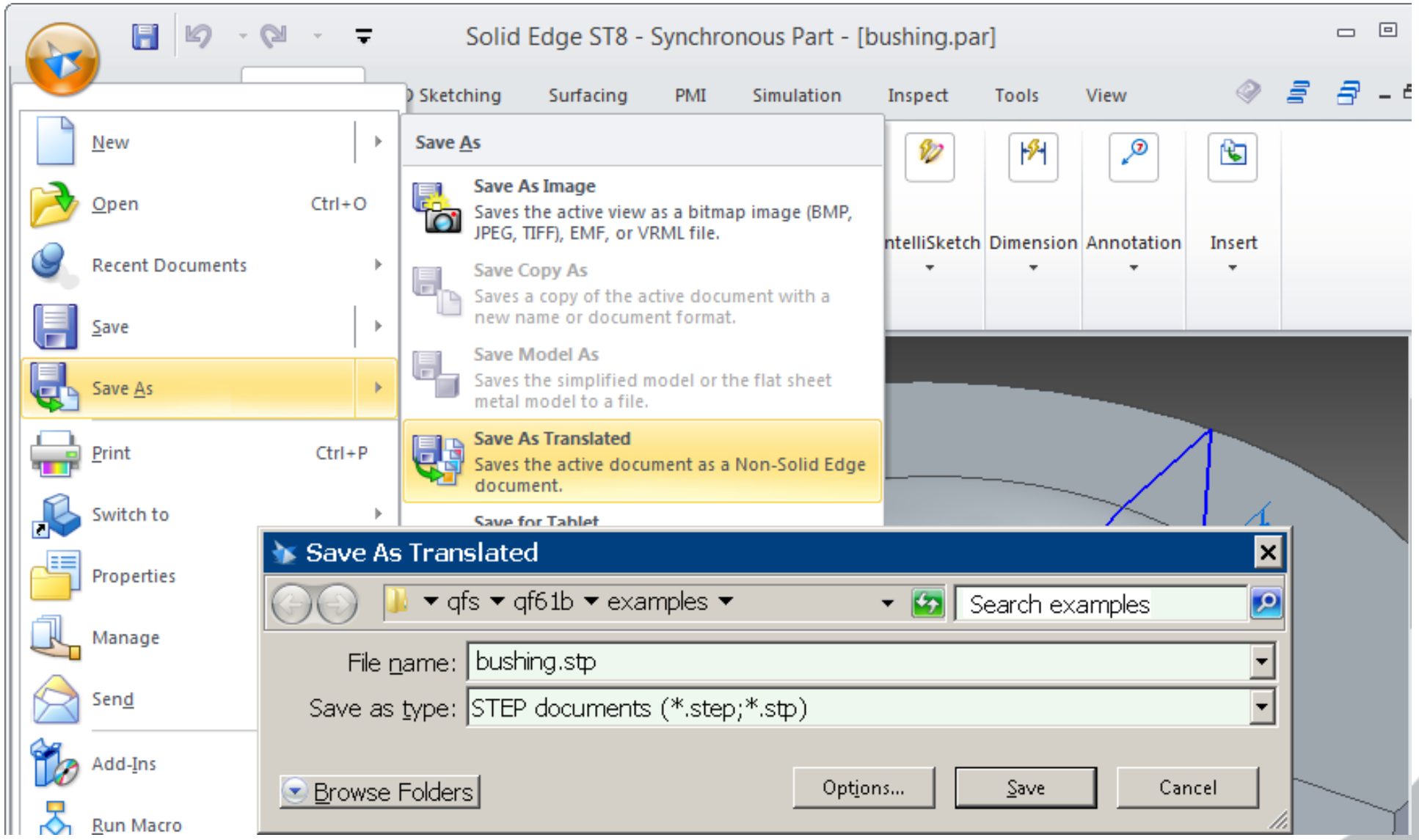
STEP file export from Rhino



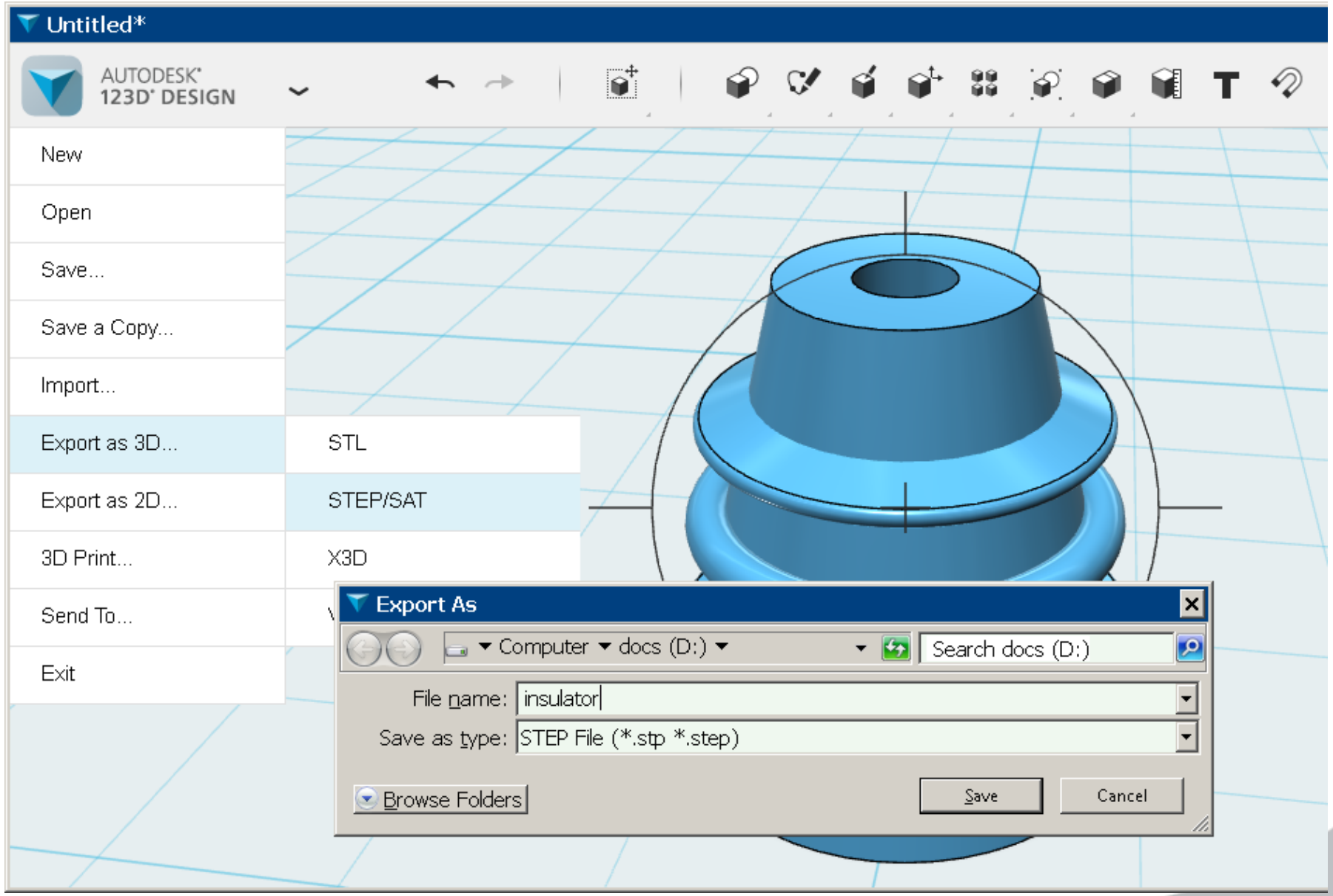
STEP file export from SOLIDWORKS



STEP file export from Solid Edge

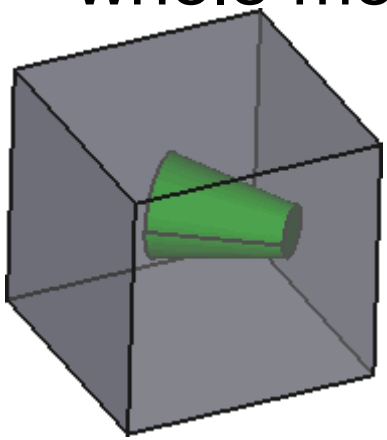


STEP file export from AutoDesk 123D' Design

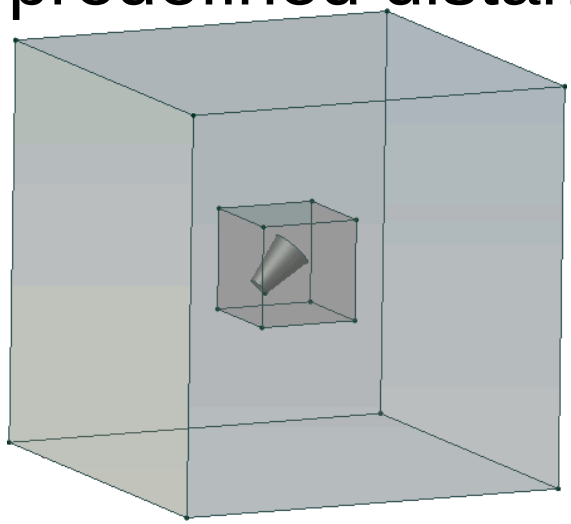


QuickField 3D CAD Import

- Compatibility with all major free and commercial CAD packages (SOLIDWORKS, Solid Edge, FreeCAD, Rhino etc.)
- STEP file import (ISO 10303)
- One body and multiple shells
- Background region (rectangular box) enclosing the whole model at the predefined distance



STEP file



QuickField 3D geometry model

http://quickfield.com/glossary/3dimport.htm

Magnetic core losses

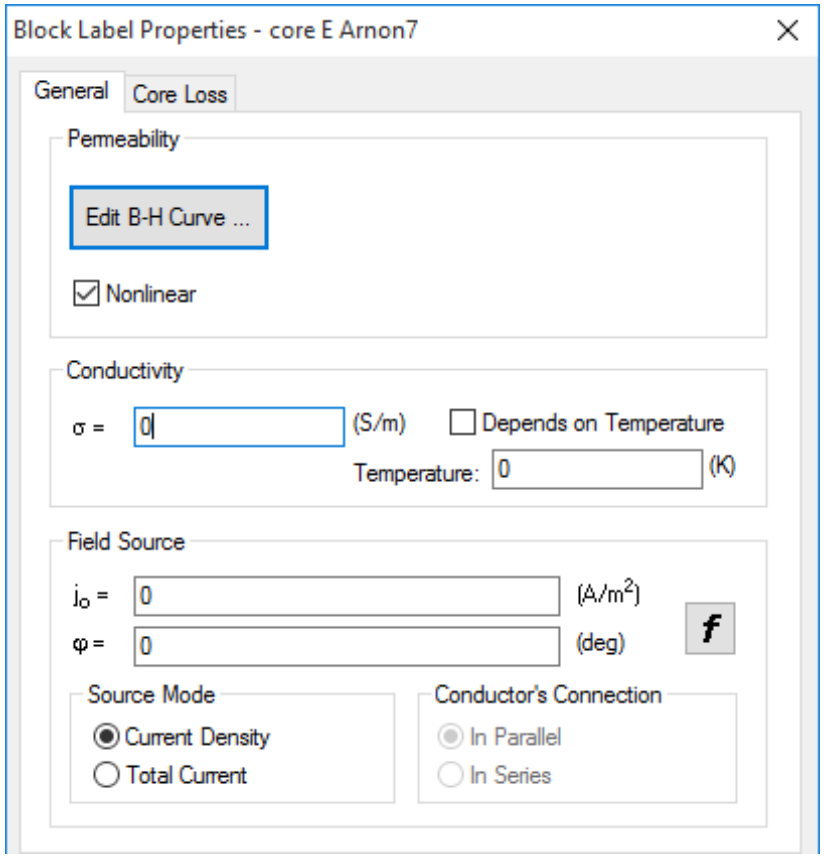
Bertotti expression:
P=Physt+Peddy+Pexcess

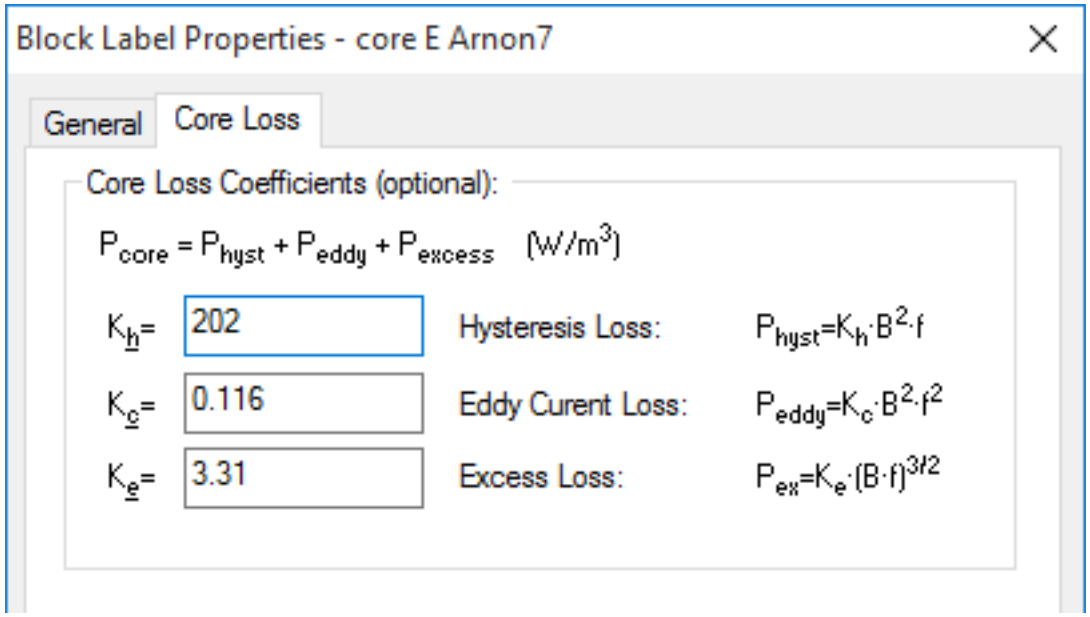
$$P_{hyst} = k_h \cdot f \cdot B_m^2$$

$$P_{eddy} = k_c \cdot f^2 \cdot B_m^2$$

$$P_{excess} = k_e \cdot (f \cdot B_m)^{3/2}$$

Core iron losses





QuickField 6.2 Editions

	QuickField Student Edition	*QuickField Lite Edition*	*QuickField Professional Edition*
Mesh size limit	2D: 255 nodes 3D: 4000 nodes	2D: about 4000 nodes 3D: No artificial restrictions	No artificial restrictions
Cost	**F R E E**	Online quote may be generated at QuickField.com>Product>Order	
License term	Permanent	per year	per year or permanent
Network licensing availability	single-user only	License permits **unlimited** number of concurrent QuickField sessions within a campus	Single-user and agreed number of floating network licenses are available
Licensing requirements	no restrictions	Academic only	No restrictions, however, commercial and academic licensing terms are different

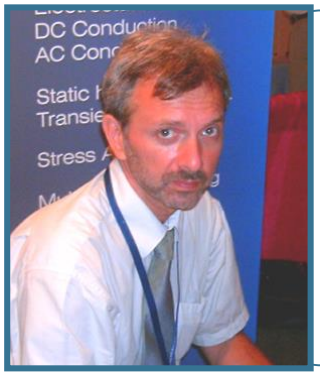
QuickField 6.2 pricing

- 3D package = 2D package + 3D Kit (Electric or Thermal)
- 3D DC Conduction is a free upgrade for customers under maintenance, already having 3D Electrostatics (same 3D Electric kit required)
- For previously available configurations – prices same or slightly lower than in QuickField 6.1
- Older licenses may be updated for 40% of the current cost of compatible configuration. One year maintenance is included.
- 12 months maintenance extension costs 16.5%
- Academic pricing - without changes comparing to QuickField 6.1

Prices depend on the set of analysis options, number of seats and region. Automatic quote generator at

http://www.quickfield.com/order.htm

What's new in QuickField 6.2



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New features overview

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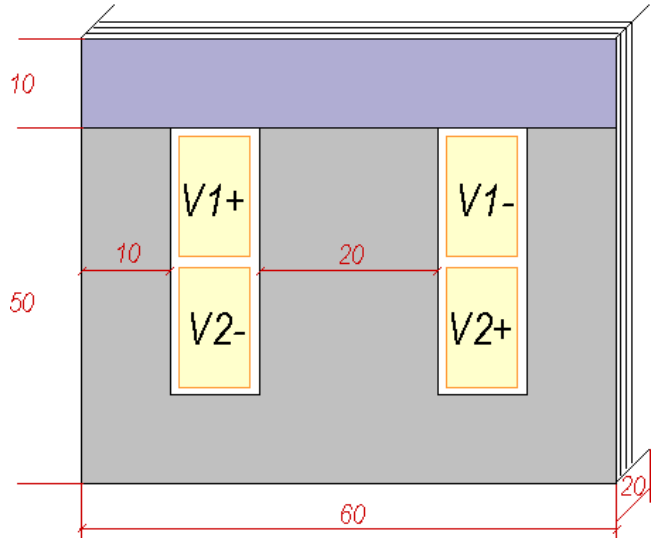
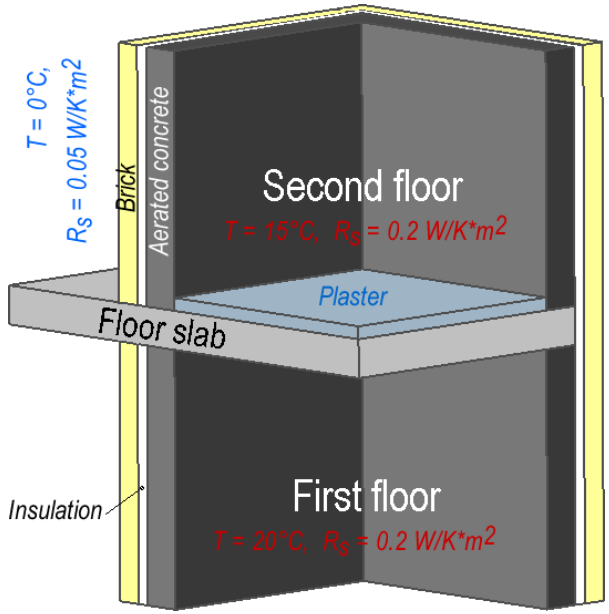
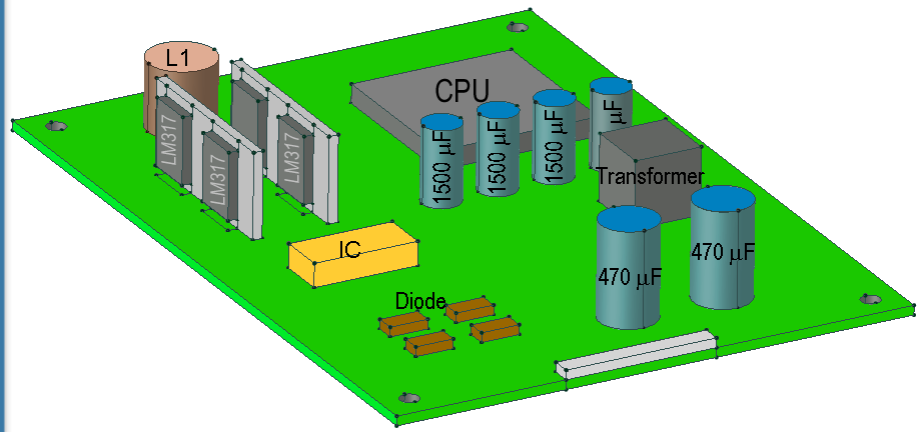
What's new in QuickField 6.2



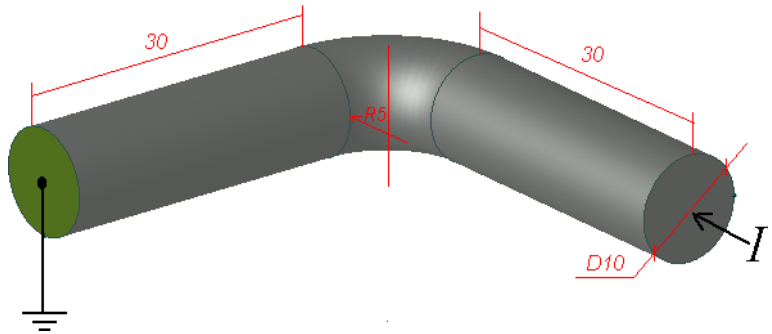
Laminated iron core losses



ISO 10211:2007 Thermal bridges in building construction.

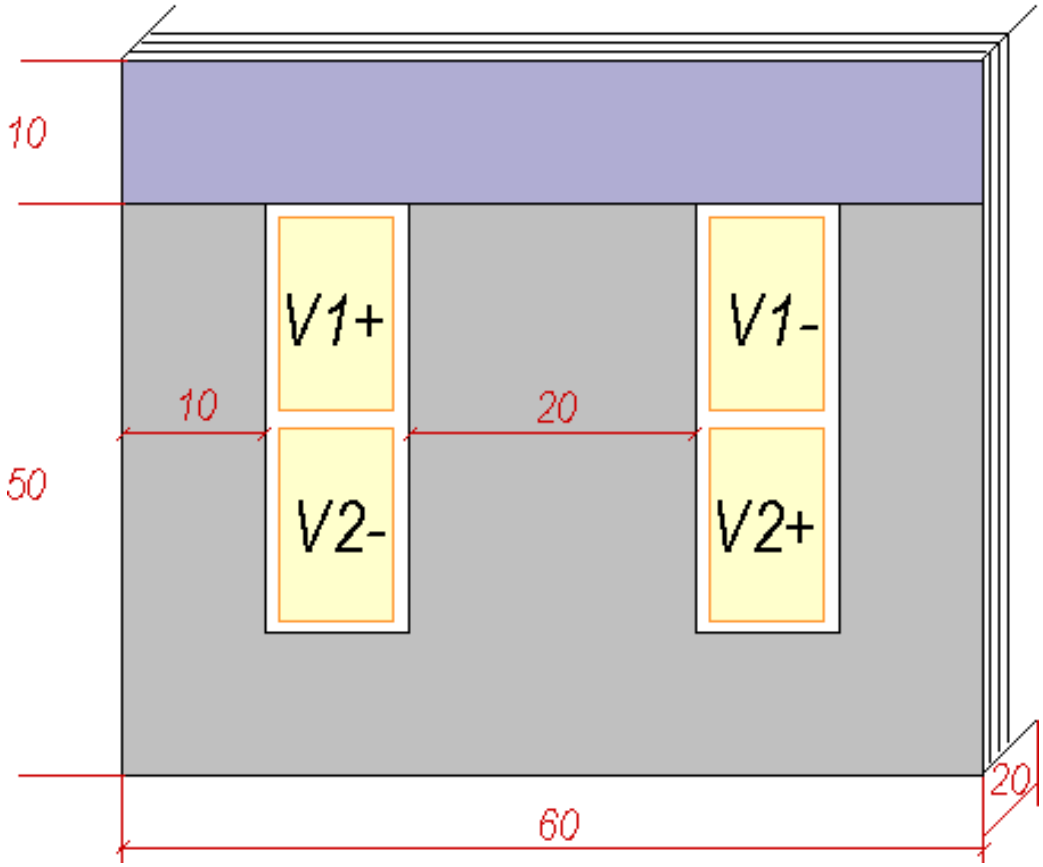


PCB thermal analysis



Bent copper wire resistance

Laminated iron core losses



Problem specification:

Core permeability – *nonlinear**
Material density ρ = 7650 kg/m^3,
Frequency *f* = 400 Hz.
Winding 1 (primary):
- no-load current 16.5 mA,
- number of turns 324,
- average turn length 111 mm.
- conductor cross-section 0.19 mm^2

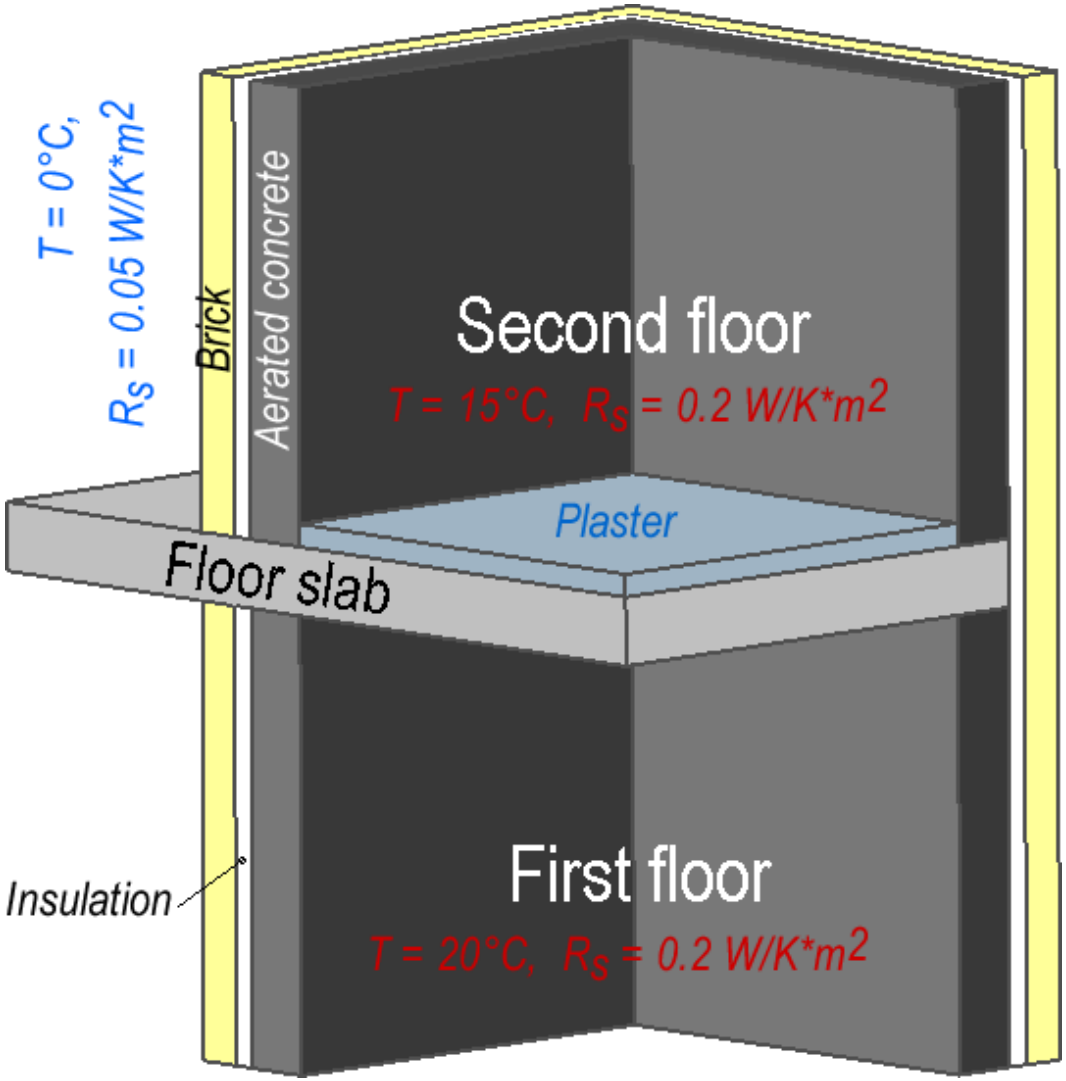
*Core loss data and magnetization curves of Arnon™5 non-grain oriented electrical steel are provided by Arnold Magnetics.

Task:

Calculate the core losses in the no-load mode of transformer.

http://quickfield.com/advanced/laminated_core_iron_loss.htm

ISO 10211:2007
Thermal bridges in building construction



Problem specification:

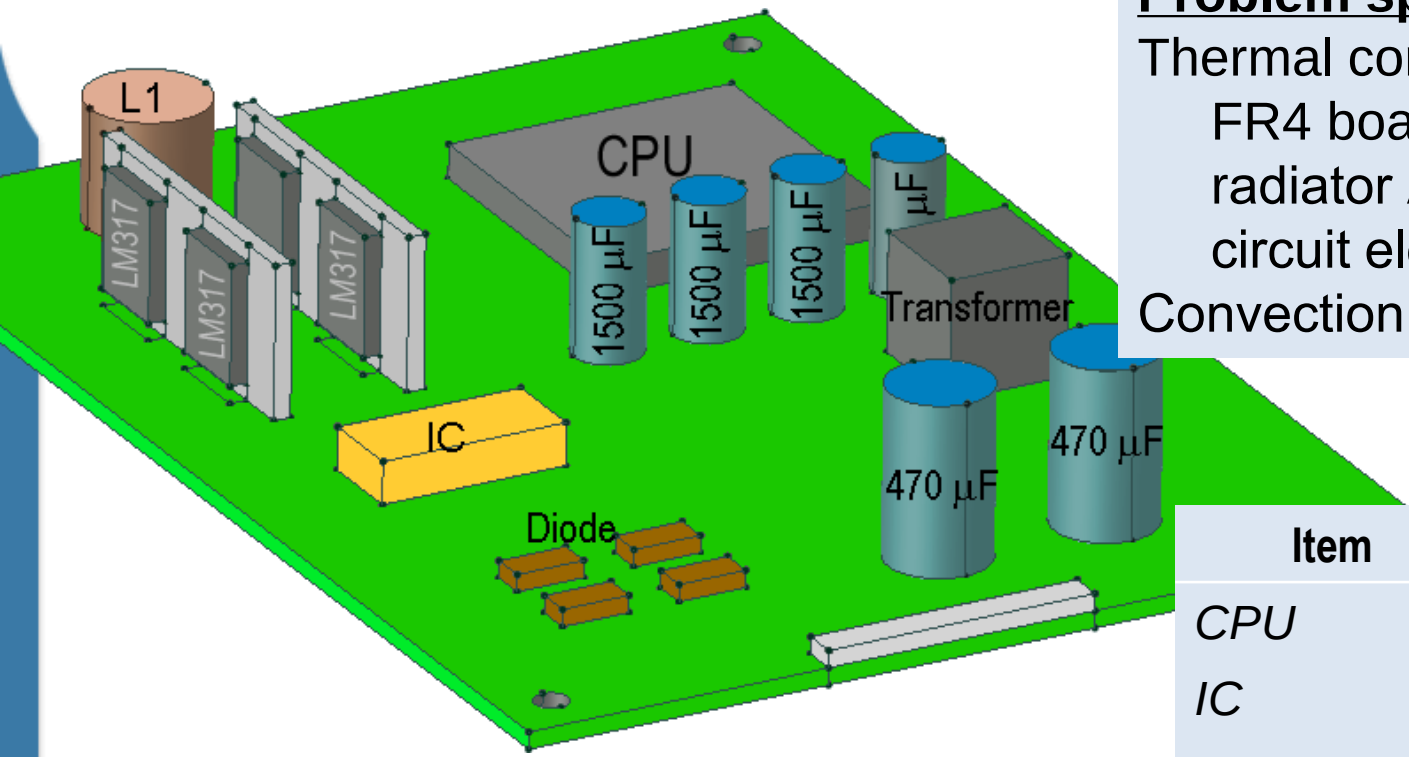
Thermal conductivity of materials
- AAC λ_1 = 0.7 W/K·m.
- insulation λ_2 = 0.04 W/K·m.
- brick λ_3 = 1.0 W/K·m.
- concrete slab λ_4 = 2.5 W/K·m.
- plaster λ_5 = 1 W/K·m.

Task:

Calculate temperature distribution

http://quickfield.com/advanced/iso_10211_2007_case3.htm

PCB thermal analysis



Problem specification:

Thermal conductivity of

FR4 board $\lambda = 0.25$ W/K·m;

radiator $\lambda = 200$ W/K·m;

circuit elements $\lambda = 1$ W/K·m;

Convection coefficient $\alpha = 12$ W/K·m^2

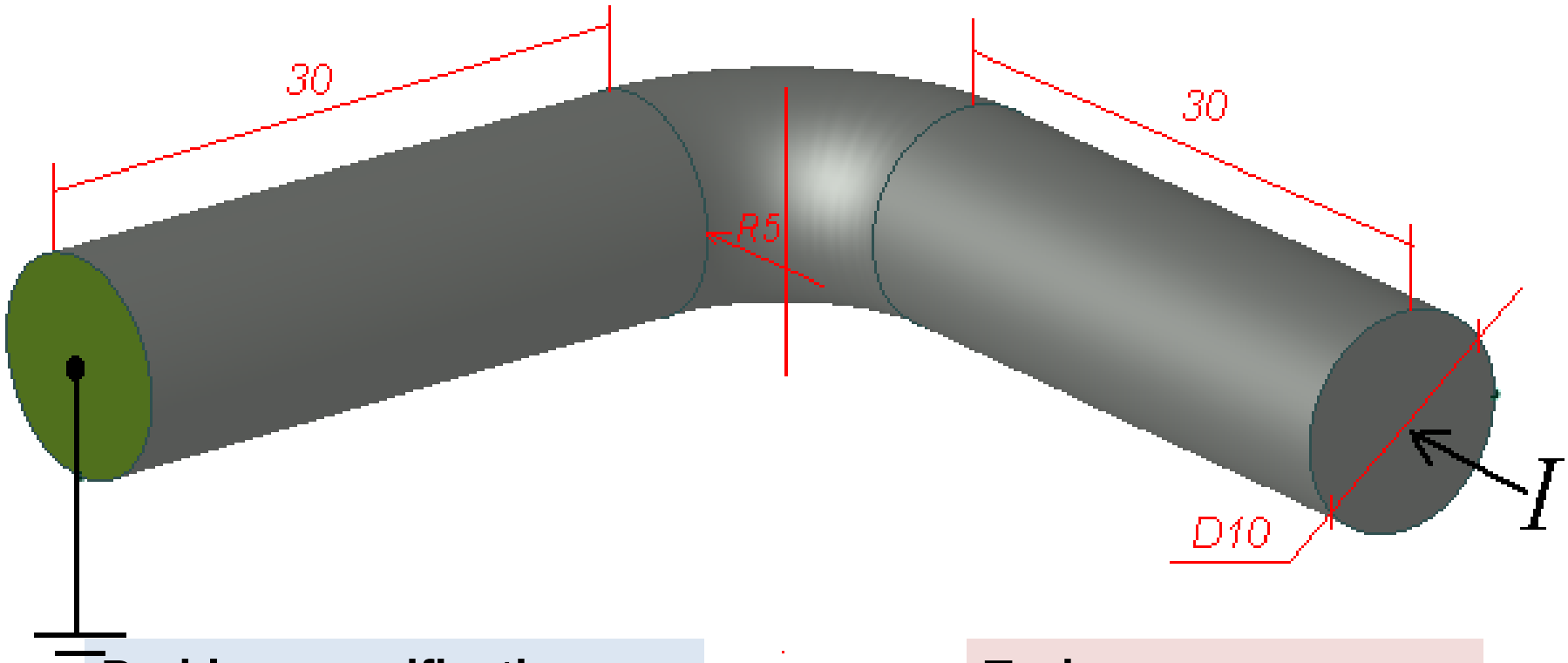
Item	Loss [W]	Volume [cm^3]
CPU	2.5	4.62
IC	0.5	1.1
LM317	0.5	0.28
470 uF	0.2	2.26
1500 uF	0.15	0.8
Transformer	0.4	2.74
Diode	0.1	0.064
L1	0.1	2.08

Task:

Calculate temperature distribution

http://quickfield.com/advanced/pcb_temperature.htm

Bent copper wire resistance



Problem specification:

Copper electric conductivity
σ = 56e6 S/m.

Current I = 100 A

Task:

Calculate resistance.

$R = \Delta V / I$ [Ohm]

http://quickfield.com/advanced/bent_copper_wire_resistance.htm